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The image shows a top-down view of a silicon die with a grid overlay. The die is rectangular and contains various circuit patterns. The text labels are located in the lower-left quadrant of the die. The grid is composed of thin, light-colored lines forming a regular pattern across the die. The background of the die is a dark, textured surface.

2 μm



A horizontal scale bar is located at the bottom left of the image, below the text '2 μm'. The bar is a solid black line.